MECHANICAL DATA

KTT (R-PSFM-G3) PLASTIC FLANGE-MOUNT PACKAGE

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion. Mold flash or protrusion not to exceed 0.005 (0,13) per side.
▲ Falls within JEDEC TO-263 variation AA, except minimum lead thickness and minimum exposed pad length.

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